



Power MOSFETS

DATASHEET

LM1A014NHT3A

N-Channel
Enhancement Mode MOSFET

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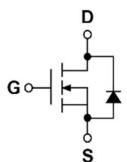
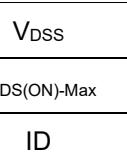
Quality Management Systems
ISO 9001:2015 Certificate

LM1A014NHT3A

N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

TO-247-3L	Symbol	Symbol	N-Channel	Unit
			V_{DSS}	100
			$R_{DS(ON)-Max}$	1.68
			ID	411

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Battery Management System

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM1A014NHT3A	TO-247-3L	Tube	30 / Tube	1A014 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		N-Channel	Unit
V_{DSS}	Drain-Source Voltage		100	V
V_{GSS}	Gate-Source Voltage		± 20	
T_J	Maximum Junction Temperature		150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55 to 150	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	258	A
$I_{DM}^{\text{(1)}}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	1028	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	411	
		$T_c=100^\circ\text{C}$	260	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	284	
		$T_c=100^\circ\text{C}$	114	W
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	43	
		$T_A=70^\circ\text{C}$	35	A
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	3.1	
		$T_A=70^\circ\text{C}$	2.0	W
$I_{AS}^{\text{(2)}}$	Avalanche Current, Single pulse	L=0.1mH	105	
		L=0.5mH	72	A
$E_{AS}^{\text{(2)}}$	Avalanche Energy, Single pulse	L=0.1mH	550	
		L=0.5mH	1300	mJ

Thermal Characteristics

Symbol	Parameter		Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	0.44	$^\circ\text{C}/\text{W}$
$R_{\theta JA}^{\text{(3)}}$	Thermal Resistance-Junction to Ambient	Steady State	40	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by junction limit

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

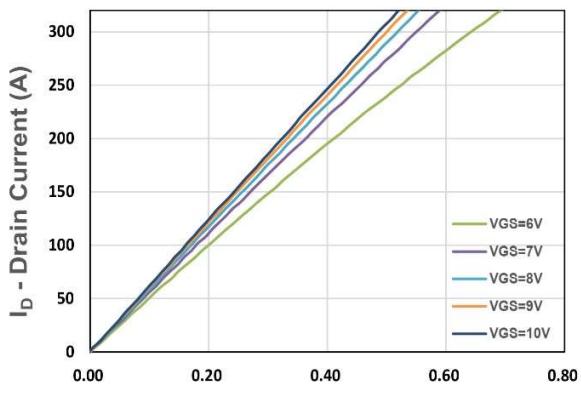
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	2	3	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=100\text{A}$	-	1.4	1.68	$\text{m}\Omega$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	4	-	S
Dynamic Characteristics ^④						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	1	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=50\text{V}$, Freq.=1MHz	-	18320	-	pF
C_{oss}	Output Capacitance		-	6095	-	
C_{rss}	Reverse Transfer Capacitance		-	556	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=1\text{A}, R_{\text{GEN}}=1\Omega$	-	70.8	-	nS
t_{r}	Turn-on Rise Time		-	37.9	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	162.1	-	
t_{f}	Turn-off Fall Time		-	358.3	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=6\text{V}, V_{\text{DS}}=50\text{V}$ $I_{\text{D}}=100\text{A}$	-	205	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=100\text{A}$	-	313	-	
Q_{gs}	Gate-Source Charge		-	97.8	-	
Q_{gd}	Gate-Drain Charge		-	83.7	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=50\text{A}$, $V_{\text{R}}=50\text{V}$	-	147	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	419	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

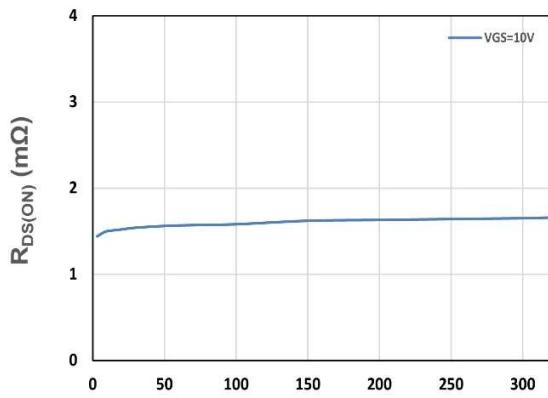
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N-Channel Typical Characteristics



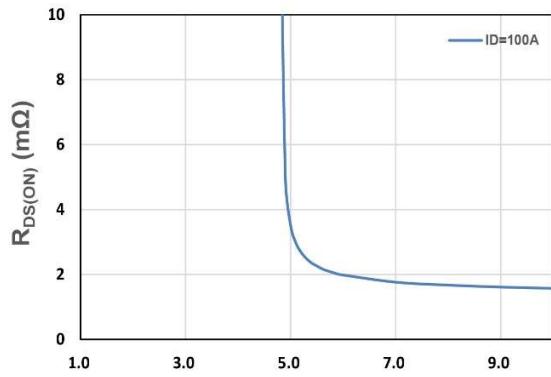
V_{DS} - Drain - Source Voltage (V)

Figure 1. Output Characteristics



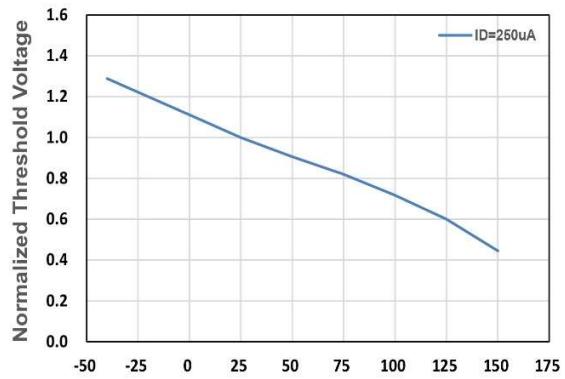
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



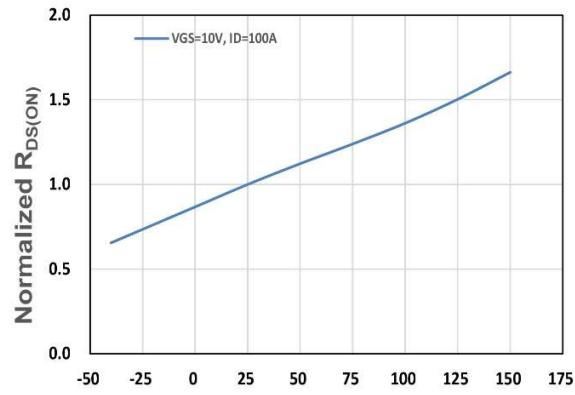
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



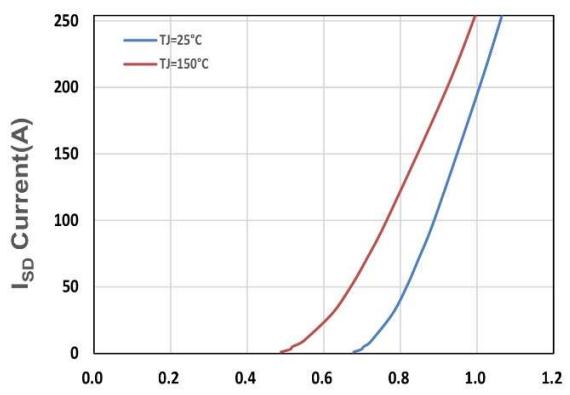
T_j , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



T_j , Junction Temperature(°C)

Figure 5. Drain-Source On Resistance

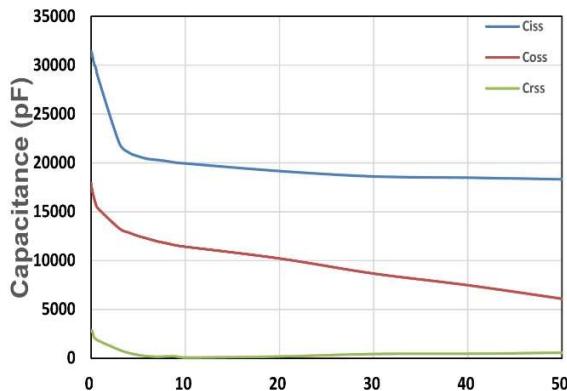


V_{SD} , Source-Drain Voltage(V)

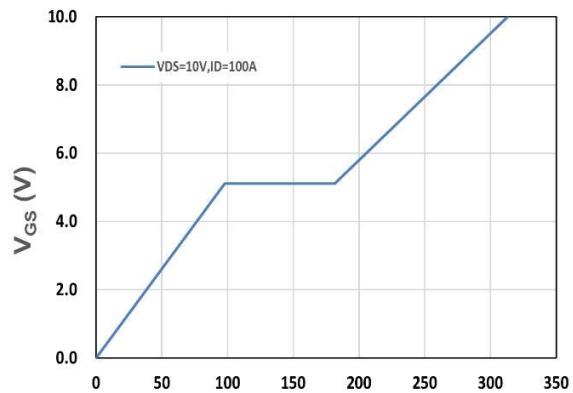
Figure 6. Source-Drain Diode Forward

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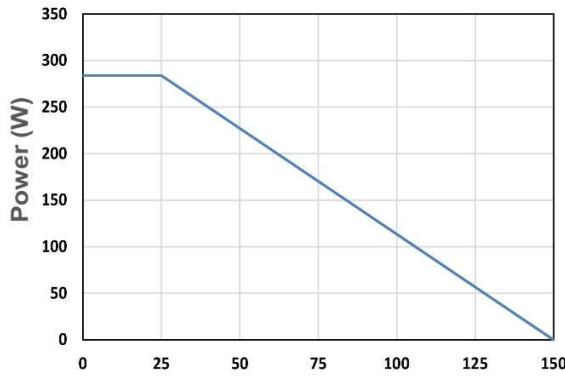
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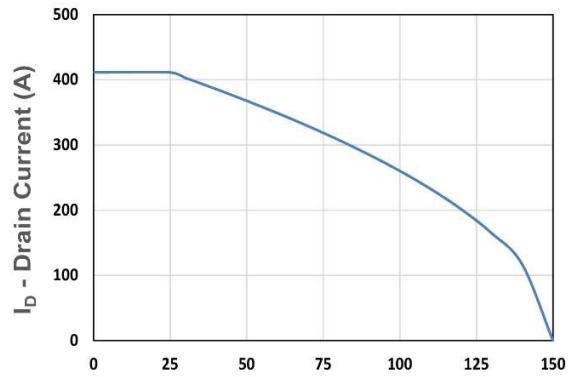
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



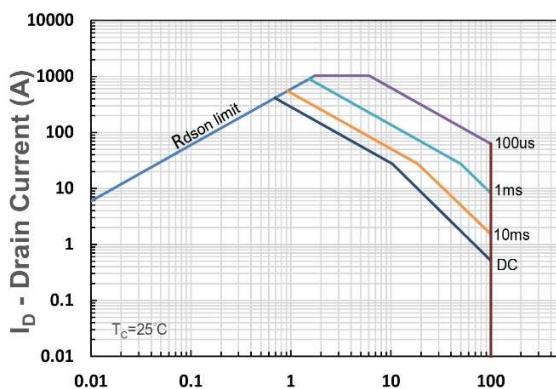
Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



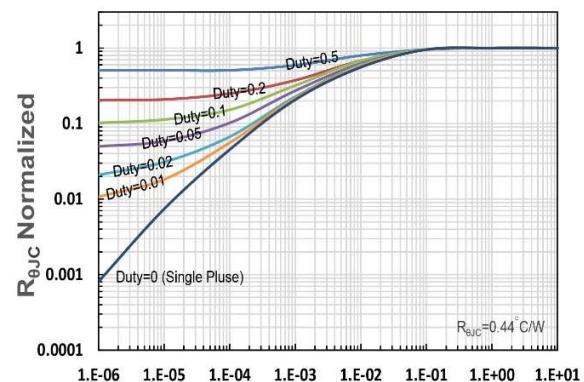
T_c - Case Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



R_{djc} Normalized
 t_1 , Square Wave Pulse Duration(s)
Figure 12. R_{djc} Transient Thermal Impedance